

### Micro-MaTch | Micro-MaTch Industrial

TE Internal #: 215460-6

Micro-MaTch Industrial, Ribbon Cable Connectors, Cable-to-Board, 6 Position, 2.54mm [.1in] Centerline, Right Angle, Through Hole -

Solder

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Cable-to-Board

Number of Positions: 6

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: With

PCB Mount Retention Type: Kinked Legs

### **Features**

### **Product Type Features**

| Ribbon Cable Connector Type       | Female-on-Board       |
|-----------------------------------|-----------------------|
| Connector Product Type            | Connector Assembly    |
| Connector System                  | Cable-to-Board        |
| Connector & Housing Type          | Receptacle            |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |

### **Configuration Features**

| Number of Positions   | 6           |
|-----------------------|-------------|
| PCB Mount Orientation | Right Angle |
| Number of Rows        | 2           |

### **Electrical Characteristics**

| Insulation Resistance | 1000 ΜΩ |
|-----------------------|---------|
| Operating Voltage     | 100 VAC |

### **Body Features**

| Connector Profile | Standard |  |
|-------------------|----------|--|
|                   |          |  |

### **Contact Features**

| Contact Layout  | Staggered                     |
|---|-------------------------------|
| PCB Contact Termination Area Plating Material Thickness | 3 – 5 μm[118.11 – 196.85 μin] |



| Contact Type   | Receptacle                    |
|--|-------------------------------|
| Contact Mating Area Plating Material Thickness       | 3 – 5 μm[118.11 – 196.85 μin] |
| Contact Mating Area Plating Material                 | Tin                           |
| PCB Contact Termination Area Plating Material Finish | Matte                         |
| Contact Mating Area Plating Material Finish          | Matte                         |
| Contact Underplating Material                        | Nickel                        |
| PCB Contact Termination Area Plating Material        | Tin                           |
| Contact Base Material                                | Phosphor Bronze               |
| Contact Current Rating (Max)                         | 1.5 A                         |
| Termination Features                                 |                               |
| Termination Method to Printed Circuit Board          | Through Hole - Solder         |
| Mechanical Attachment                                |                               |
| Mating Alignment                                     | With                          |
| PCB Mount Alignment                                  | Without                       |
| PCB Mount Retention                                  | With                          |
| PCB Mount Retention Type                             | Kinked Legs                   |
| Mating Alignment Type                                | Polarization                  |
| Mating Retention                                     | Without                       |
| Connector Mounting Type                              | Board Mount                   |
| Housing Features                                     |                               |
| Mating Entry Location                                | Side                          |
| Housing Material                                     | Glass Filled PBT              |
| Housing Color  | Red                           |
| Centerline (Pitch)                                   | 2.54 mm[.1 in]                |
| Dimensions   |                               |
| Row-to-Row Spacing                                   | 1.5 mm[.059 in]               |
| Usage Conditions                                     |                               |
| Operating Temperature Range                          | -40 - 105 °C[-40 - 221 °F]    |
| Operation/Application                                |                               |
| Circuit Application                                  | Signal                        |
| Industry Standards                                   |                               |
| UL Rating  | Recognized                    |
|  |                               |



| UL File Number                        | E28476   |
|---------------------------------------|----------|
| Agency/Standard                       | UL       |
| UL Flammability Rating                | UL 94V-0 |
|                                       |          |
| Packaging Features                    |          |
| Packaging Features Packaging Quantity | 2500     |

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant  |
|---|--|
| EU ELV Directive 2000/53/EC                   | Compliant  |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold  |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2020 (205) SVHC > Threshold: Not Yet Reviewed |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.   |
| Solder Process Capability                     | Wave solder capable to 265°C   |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts









# Also in the Series | Micro-MaTch Industrial



Board-to-Board Headers & Receptacles(1)



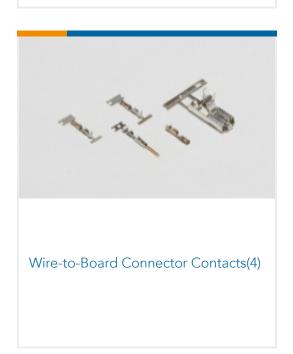
Insertion & Extraction Tools(1)



Pluggable I/O Cable Assemblies(52)



Ribbon Cable Connectors(204)



# Customers Also Bought























### **Documents**

### **Product Drawings**

MICRO-MATCH FEM.SE

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_215460-6\_J.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_215460-6\_J.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_215460-6\_J.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### Datasheets & Catalog Pages

Micro-MaTch Catalog

English

**Ribbon Cable Interconnect Solutions** 

English

Centerline Micro-Match Connector Series

English

### **Product Specifications**

**Product Specification** 

English

## **Product Environmental Compliance**

TE Material Declaration

English

### **Agency Approvals**

**UL Report** 

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English